

# **Film Capacitors**

# Metallized Polypropylene Film Capacitors (MKP)

 Series/Type:
 B32774 ... B32778

 Date:
 May 2011

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#### Metallized polypropylene film capacitors (MKP)

#### MKP DC link - high density series

#### B32774 ... B32778

#### **Typical applications**

For compact design of:

- Frequency converters
- Industrial and high-end power supplies
- Solar inverters

#### Climatic

- Max. operating temperature: 105 °C (case)
- Climatic category (IEC 60068-1): 40/85/56

#### Construction

- Dielectric: polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

#### Features

- Capacitance values up to 110 µF
- High CV product, compact
- Excellent self-healing properties
- Overvoltage capability
- Low losses with high current capability
- High reliability
- Long useful life

#### Terminals

- Parallel wire leads, lead-free tinned
- 2-pin and 4-pin versions
- Standard lead lengths: 6 -1 mm
- Special lead lengths are available on request

#### Marking

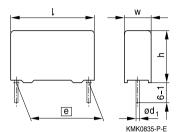
Manufacturer's logo, lot number, date code, rated capacitance (coded), capacitance tolerance (code letter), rated DC voltage

#### **Delivery mode**

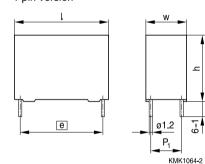
Bulk (untaped, lead length 6 -1 mm)

#### Dimensional drawings

2-pin version







#### Dimensions in mm

Version	Lead spacing <i>e</i> _±0.4	Lead diameter d <sub>1</sub>	Туре
2-pin	27.5	0.8	B32774D
2-pin	37.5	1.0	B32776E
4-pin	37.5	1.2	B32776G
4-pin	52.5	1.2	B32778G



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# Overview of available types

Lead spacing	27.5 r	nm			37.5 mm			52.5 mm					
Туре	B327	74			B327	76			B327	78			
Page	4				5				7	7			
V <sub>R</sub> (V DC)	450	800	1100	1300	450	800	1100	1300	450	800	1100	1300	
C <sub>R</sub> (μF)													
1.5													
2.0													
3.0													
5.0													
7.0													
8.0													
10													
12													
14													
15													
16													
20													
22													
25													
27													
30													
35													
40													
45													
50													
55													
60													
75													
80													
100													
110													





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### Ordering codes and packing units (lead spacing 27.5 mm)

C <sub>R</sub>	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS,max</sub>	I <sub>RMS,max</sub>	ESR <sub>typ</sub>	Untaped		
	$w \times h \times I$		(composition see	70 °C	70 °C	70 °C			
			below)	10 kHz	20 kHz	10 kHz			
μF	mm	mm		А	А	mΩ	pcs./MOQ		
V <sub>R,70</sub> ° <sub>C</sub>	= 450 V DC, V <sub>op,85</sub> °C	<sub>c</sub> = 4	50 V DC						
5.0	$11.0 \times 21.0 \times 31.5$	-	B32774D4505+000	5.0	4.5	8.5	2352		
10	$15.0\times24.5\times31.5$	—	B32774D4106+000	6.5	6.0	7.5	1680		
22	$22.0\times36.5\times31.5$	-	B32774D4226+000	10.0	9.0	5.0	784		
V <sub>R,70</sub> ° <sub>C</sub>	$V_{B,70\ ^{\circ}C} = 800 \text{ V DC}, V_{op,85\ ^{\circ}C} = 700 \text{ V DC}$								
3.0	$11.0 \times 21.0 \times 31.5$	-	B32774D8305+000	5.0	4.5	9.0	2352		
5.0	$14.0 \times 24.5 \times 31.5$	—	B32774D8505+000	5.0	4.5	7.0	1848		
12	$22.0\times36.5\times31.5$	—	B32774D8126+000	6.0	5.5	6.5	784		
V <sub>R,70 °C</sub>	= 1100 V DC, $V_{op,85}$ °C	c = 9	20 V DC						
2.0	$12.5 \times 21.5 \times 31.5$	-	B32774D0205+000	4.0	3.5	11.0	2100		
5.0	$19.0\times30.0\times31.5$	—	B32774D0505+000	6.5	6.0	7.0	896		
7.0	$22.0\times36.5\times31.5$	—	B32774D0705+000	7.5	7.0	5.5	784		
V <sub>R,70</sub> ° <sub>C</sub>	= 1300 V DC, V <sub>op,85</sub> °C	c = 11	00 V DC						
1.5	$12.5 \times 21.5 \times 31.5$	-	B32774D1155+000	4.5	4.0	10.5	2100		
3.0	$18.0 \times 27.5 \times 31.5$	-	B32774D1305+000	6.0	5.5	7.0	1428		
5.0	$22.0\times36.5\times31.5$	-	B32774D1505+000	8.0	7.0	6.0	784		

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

#### Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$ 

 $J = \pm 5\%$ 



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MKP → 37.5 →

# Ordering codes and packing units (lead spacing 37.5 mm)

$\begin{array}{c c c c c c c c c c c c c c c c c c c $	C <sub>R</sub>	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS,max</sub>	I <sub>RMS,max</sub>	ESR <sub>tvp</sub>	Untaped
$\begin{array}{ c c c c c c c } \hline \mu F & mm & mm & hole $	-11			-				
$\begin{array}{c c c c c c c c c c c c c c c c c c c $				· ·				
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	uЕ	mm	mm	501011)	-	-	-	pcs /MOQ
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	·				<u>  ^ </u>		1	pool/mod
$\begin{array}{cccccccccccccccccccccccccccccccccccc$					40.5	44 -		0.40
$\begin{array}{cccccccccccccccccccccccccccccccccccc$			10.2		-	-		
$\begin{array}{cccccccccccccccccccccccccccccccccccc$			-		-			
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			10.2					-
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			-		-	-		-
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$			10.2					-
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			-			-		-
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$			10.2					
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			-				-	-
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	60	$30.0\times45.0\times42.0$	-	B32776E4606+000	16.5	15.0	3.0	400
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	V <sub>R,70</sub> ° <sub>C</sub>	= 800 V DC, $V_{op,85}$ °C	<sub>c</sub> = 70	0 V DC				
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	14	$18.0\times32.5\times41.5$	-	B32776E8146+000	10.0	9.0	7.5	720
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	15	$20.0\times39.5\times41.5$	10.2	B32776G8156+000	10.5	9.5	7.0	640
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	20	$28.0\times37.0\times42.0$	10.2	B32776G8206+000	12.0	11.0	5.5	440
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	20	$28.0\times37.0\times42.0$	-	B32776E8206+000	11.5	10.5	6.5	440
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	22	$28.0\times37.0\times42.0$	10.2	B32776G8226+000	13.0	12.0	5.0	440
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	25	$28.0 \times 42.5 \times 41.5$	_	B32776E8256+000	13.5	12.5	4.5	440
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	30	30.0 imes45.0 imes42.0	20.3	B32776G8306+000	15.0	14.0	3.5	400
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	30	$30.0 \times 45.0 \times 42.0$	-	B32776E8306+000	14.0	13.0	5.0	400
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	V <sub>R,70 °C</sub>	= 1100 V DC, V <sub>op,85</sub> °	<sub>c</sub> = 92	0 V DC				
14       28.0 × 37.0 × 42.0       10.2       B32776G0146+000       13.0       12.0       5.5       440         14       28.0 × 37.0 × 42.0       -       B32776E0146+000       12.0       11.0       6.0       440         16       28.0 × 42.5 × 41.5       10.2       B32776E0166+000       13.0       12.0       5.0       440         16       28.0 × 42.5 × 41.5       -       B32776E0166+000       12.0       11.0       5.5       440         20       30.0 × 45.0 × 42.0       20.3       B32776G0206+000       15.0       13.0       3.0       400	-	1			11.0	10.0	6.5	640
14       28.0 × 37.0 × 42.0       -       B32776E0146+000       12.0       11.0       6.0       440         16       28.0 × 42.5 × 41.5       10.2       B32776G0166+000       13.0       12.0       5.0       440         16       28.0 × 42.5 × 41.5       -       B32776E0166+000       12.0       11.0       5.5       440         20       30.0 × 45.0 × 42.0       20.3       B32776G0206+000       15.0       13.0       3.0       400	12	$20.0 \times 39.5 \times 41.5$	-	B32776E0126+000	10.0	9.0	7.0	640
16       28.0 × 42.5 × 41.5       10.2       B32776G0166+000       13.0       12.0       5.0       440         16       28.0 × 42.5 × 41.5       -       B32776E0166+000       12.0       11.0       5.5       440         20       30.0 × 45.0 × 42.0       20.3       B32776G0206+000       15.0       13.0       3.0       400	14	$28.0 \times 37.0 \times 42.0$	10.2	B32776G0146+000	13.0	12.0	5.5	440
16         28.0 × 42.5 × 41.5         -         B32776E0166+000         12.0         11.0         5.5         440           20         30.0 × 45.0 × 42.0         20.3         B32776G0206+000         15.0         13.0         3.0         400		$28.0 \times 37.0 \times 42.0$	_				6.0	440
16         28.0 × 42.5 × 41.5         -         B32776E0166+000         12.0         11.0         5.5         440           20         30.0 × 45.0 × 42.0         20.3         B32776G0206+000         15.0         13.0         3.0         400	16	$28.0 \times 42.5 \times 41.5$	10.2	B32776G0166+000	13.0	12.0	5.0	440
20 30.0 × 45.0 × 42.0 20.3 B32776G0206+000 15.0 13.0 3.0 400			_					-
	-		20.3			-		-
	20	$30.0 \times 45.0 \times 42.0$		B32776E0206+000	13.0	12.0	3.5	

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

#### Composition of ordering code

+ = Capacitance tolerance code:

 $\begin{array}{l} \mathsf{K}=\pm10\%\\ \mathsf{J}=\pm5\% \end{array}$ 





MKP DC link - high density series

# Ordering codes and packing units (lead spacing 37.5 mm)

C <sub>R</sub>	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS,max</sub>	I <sub>RMS,max</sub>	ESR <sub>typ</sub>	Untaped			
	$w \times h \times I$		(composition see	70 °C	70 °C	70 °C				
			below)	10 kHz	20 kHz	10 kHz				
μF	mm	mm		А	А	mΩ	pcs./MOQ			
V <sub>R,70 °C</sub>	V <sub>B,70 °C</sub> = 1300 V DC, V <sub>op,85 °C</sub> = 1100 V DC									
8.0	$20.0\times39.5\times41.5$	10.2	B32776G1805+000	9.0	8.0	8.0	640			
10	$28.0\times37.0\times42.0$	10.2	B32776G1106+000	12.0	11.0	6.5	440			
10	$28.0\times37.0\times42.0$	-	B32776E1106+000	11.0	10.0	7.0	440			
12	$28.0\times42.5\times41.5$	10.2	B32776G1126+000	13.0	12.0	5.5	440			
14	$30.0\times45.0\times42.0$	-	B32776E1146+000	13.0	12.0	5.0	400			

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

#### Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$  $J = \pm 5\%$ 



МКР 52.5 →

# MKP DC link – high density series

# Ordering codes and packing units (lead spacing 52.5 mm)

C <sub>B</sub>	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS,max</sub>	I <sub>RMS,max</sub>	ESR <sub>tvp</sub>	Untaped		
	$w \times h \times I$	-	(composition see	70 °C	70 °C	70 °℃			
			below)	10 kHz	20 kHz	10 kHz			
μF	mm	mm	,	А	А	mΩ	pcs./MOQ		
V <sub>R,70</sub> ° <sub>C</sub>	= 450 V DC, V <sub>op,85</sub> °	<sub>c</sub> = 45	0 V DC						
75	$30.0\times45.0\times57.5$	20.3	B32778G4756+000	16.0	15.5	5.5	280		
80	$30.0\times45.0\times57.5$	20.3	B32778G4806+000	16.5	16.0	5.0	280		
100	$35.0\times50.0\times57.5$	20.3	B32778G4107+000	18.0	18.0	4.0	108		
110	$35.0\times50.0\times57.5$	20.3	B32778G4117+000	19.0	19.0	4.0	108		
V <sub>R,70 °C</sub>	= 800 V DC, V <sub>op,85</sub> °C	<sub>c</sub> = 70	0 V DC						
45	$30.0\times45.0\times57.5$	20.3	B32778G8456+000	16.0	15.0	4.0	280		
55	$35.0\times50.0\times57.5$	20.3	B32778G8556+000	17.0	16.0	3.5	108		
60	$35.0\times50.0\times57.5$	20.3	B32778G8606+000	19.0	18.0	3.0	108		
V <sub>R,70 °C</sub>	= 1100 V DC, V <sub>op,85</sub> °c	c = 92	0 V DC						
30	$30.0\times45.0\times57.5$	20.3	B32778G0306+000	16.0	14.0	5.0	280		
40	$35.0\times50.0\times57.5$	20.3	B32778G0406+000	20.0	20.0	3.5	108		
V <sub>R,70</sub> ° <sub>C</sub>	V <sub>B,70 °C</sub> = 1300 V DC, V <sub>op.85 °C</sub> = 1100 V DC								
20	$30.0\times45.0\times57.5$	20.3	B32778G1206+000	14.0	13.0	5.5	280		
25	$35.0\times50.0\times57.5$	20.3	B32778G1256+000	17.0	16.0	4.5	108		
27	$35.0\times50.0\times57.5$	20.3	B32778G1276+000	17.5	16.0	4.5	108		

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

#### Composition of ordering code

+ = Capacitance tolerance code:

K = ±10%

 $J = \pm 5\%$ 





MKP DC link - high density series

# **Technical data**

Reference standard: IEC 61071. All data given at T = 20 °C, unless otherwise specified.

		3	)		
Operating temperat	ure range (case)	Max. ope	erating ten	nperature, T <sub>op,r</sub>	<sub>max</sub> +105 °C
				mperature T <sub>max</sub>	
				mperature $T_{\min}$	−40 °C
ESR (at 10 kHz)	LS 27.5	< 3.0 · E			
	LS 37.5	< 2.5 · E			
	LS 52.5	< 2.0 · E	SR <sub>typ</sub>		
Insulation Resistance	ce R <sub>ins</sub>	30 000 s			
given as time const	ant				
$\tau = C_R \cdot R_{ins}$ , rel. hu	midity ≤ 65%				
(minimum as-delive	red values)				
DC test voltage bet	ween terminals (10 s)	$1.5 \cdot V_{R}$			
DC test voltage terr	ninal to case (10 s)	2110 V A	C, 50 Hz		
Maximum peak curr	rent (A)	$I_{P,max} = 0$	$S_{R} - \frac{dV}{dt}$		
Damp heat test		56 days/	40 °C/93%	6 relative humi	dity
Limit values after da	amp heat test	Capacita	nce chang	ge I ∆C/C I	≤ 5%
		Dissipatio	on factor o	change $\Delta$ tan $\delta$	$5 \le 1.5 \cdot 10^{-3}$ (at 1 kHz)
		Insulation	n resistan	ce R <sub>ins</sub>	$\geq$ 50% of minimum
					as-delivered values
Reliability:	Failure rate $\lambda$	50 fit (≤ 1	· 10⁻⁰/h)	at 0.5 · V <sub>R</sub> , 40	O°C
	Service life t <sub>SL</sub>		h at V <sub>R</sub> an		
		For conv	ersion to o	other operating	g conditions, refer to
		chapter "	Quality, 2	Reliability".	
V <sub>R</sub> (V DC)		450	800	1100	1300
Continuous operation	on voltage				
V <sub>op</sub> (V DC) at 70 °C		450	800	1100	1300
Continuous operation	on voltage				
V <sub>op</sub> (V DC) at 85 °C		450	700	920	1100
For temperatures be	etween	1%/°C of derating respect $V_{op}$ at 70 °C			
70 °C and 85 °C		(no derat	ing at 450	V DC series)	



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# MKP

#### Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in  $V/\mu s$ .

### Note:

The values of dV/dt provided below must not be exceeded in order to avoid damaging the capacitor.

#### dV/dt values

Lead spacing	27.5 r	nm			37.5 r	37.5 mm			52.5 mm			
Туре	B327	74			B3277	76			B3277	78		
V <sub>R</sub> (V DC)	450	800	1100	1300	450	800	1100	1300	450	800	1100	1300
C <sub>R</sub> (μF)	dV/dt	in V/µ	S									
1.5	-	_	-	100	-	-		-	-	_	-	-
2.0	-	_	75	_	_	_	_	_	_	_	_	_
3.0	-	40	-	100	-	-		-	-	_	-	-
5.0	30	40	75	100	_	_	_	_	_	_	_	_
7.0	-	-	75	-	-	-	-	-	-	-	-	-
8.0	-	_	_	_	_	_	_	73	_	_	_	_
10	30	-	-	-	-	-	-	73	-	-	-	-
12	_	40	-	_	_	_	54	73	-	_	_	_
14	-	-	-	-	-	22	54	73	-	-	-	-
15	-	-	-	-	_	22	_	-	-	-	-	-
16	-	_	_	_	_	_	54	_	_	_	_	_
20	-	-	-	-	-	22	54	_	-	-	-	50
22	30	-	-	-	-	22	-	-	-	-	-	-
25	-	_	_	_	_	22	_	_	_	_	_	50
27	-	_	-	-	_	-	-	-	-	_	-	50
30	-	-	-	-	21	22	-	-	-	-	35	_
35	-	-			21	-		-	-	-		
40	-	-			21	-		-	-	-	35	
45	-	-			_	-			-	15		
50	-	-	-	-	21	-	-	1	-	-	-	-
55	-	-	-	-	-	-	-	-	-	15	-	-
60	-	-	-	-	21	-	-	-	-	15	-	
75	-	-	-	-	-	-	-	-	14	-	-	-
80	-	-	-	-	-	-	-	-	14	-	-	-
100	-	-	-	-	-	-	-	-	14	-	-	-
110	-	-	-	-	-	_	-	_	14	-	-	-



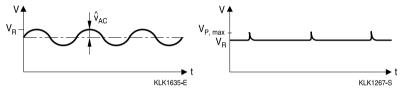


MKP DC link - high density series

#### ESL values

		ESL
2-pin	B32774D	25 nH
	B32776E	10 nH
4-pin	B32776G	15 nH
	B32778G	15 nH

# Typical waveforms



**Restrictions:** 

 $V_{R}$ : Maximum operating peak voltage of either polarity but of a non-reversing waveform, for which the capacitor has been designed for continuous operation.

 $\hat{v}_{\text{AC}} \leq \boldsymbol{0.2} \, \cdot \, \boldsymbol{V}_{\text{R}}$ 

 $V_{P,max}$ : Maximum permissible recurrent voltage that may appear for 2% of the period.



MKP DC link – high density series

# MKP

#### **Mounting guidelines**

#### 1 Soldering

#### 1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

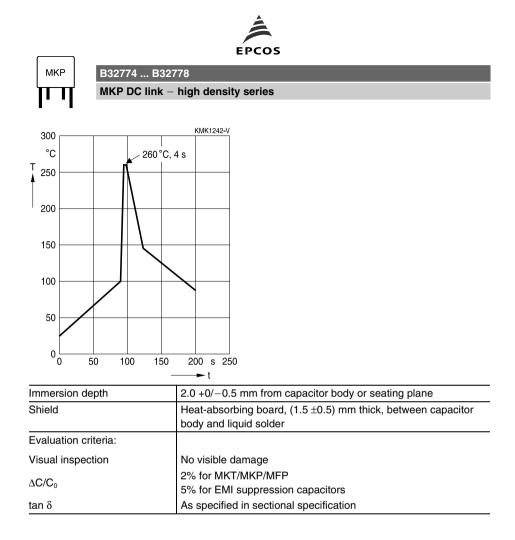
Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/ $-0.5$ mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder $\ge$ 90%, free-flowing solder

#### 1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A. Conditions:

Serie	S	Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing > 10 mm)	260 ±5 °C	10 ±1 s
MFP MKP	(lead spacing > 7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5±1 s
МКР МКТ	(lead spacing $\leq$ 7.5 mm) uncoated (lead spacing $\leq$ 10 mm) insulated (B32559)		< 4 s recommended soldering profile for MKT uncoated (lead spacing $\leq$ 10 mm) and insulated (B32559)





MKP DC link – high density series

# MKP

### 1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature  $T_{max}$ . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
- diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
  - MKP/MFP 110 °C
  - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

#### **Uncoated capacitors**

For uncoated MKT capacitors with lead spacings  $\leq$ 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering





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## 2 Cleaning

To determine whether the following solvents, often used to remove flux residues and other substances, are suitable for the capacitors described, refer to the table below:

Туре	Ethanol, isopropanol, n-propanol	n-propanol-water mixtures, water with surface tension-reducing tensides (neutral)	Solvent from table A (see next page)	Solvent from table B (see next page)
MKT (uncoated)	Suitable	Unsuitable	In part suitable	Unsuitable
MKT, MKP, MFP (coated/boxed)		Suitable	Suitable	

Even when suitable solvents are used, a reversible change of the electrical characteristics may occur in uncoated capacitors immediately after they are washed. Thus it is always recommended to dry the components (e.g. 4 h at 70  $^{\circ}$ C) before they are subjected to subsequent electrical testing.

# Table A

Manufacturers' designations for trifluoro-trichloro-ethane-based cleaning solvents (selection)

Trifluoro-trichloro- ethane	Mixtures of trifluoro-trichloro-ethane with ethanol and isopropanol	Manufacturer
Freon TF	Freon TE 35; Freon TP 35; Freon TES	Du Pont
Frigen 113 TR	Frigen 113 TR-E; Frigen 113 TR-P; Frigen TR-E 35	Hoechst
Arklone P	Arklone A; Arklone L; Arklone K	ICI
Kaltron 113 MDR	Kaltron 113 MDA; Kaltron 113 MDI; Kaltron 113 MDI 35	Kali-Chemie
Flugene 113	Flugene 113 E; Flugene 113 IPA	Rhone-Progil

#### Table B (worldwide banned substances)

Manufacturers' designations for unsuitable cleaning solvents (selection)

Mixtures of chlorinated hydrocarbons and ketones with fluorated hydrocarbons	Manufacturer
Freon TMC; Freon TA; Freon TC	Du Pont
Arklone E	ICI
Kaltron 113 MDD; Kaltron 113 MDK	Kali-Chemie
Flugene 113 CM	Rhone-Progil



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### 3 Embedding of capacitors in finished assemblies

In many applications, finished circuit assemblies are embedded in plastic resins. In this case, both chemical and thermal influences of the embedding ("potting") and curing processes must be taken into account.

Our experience has shown that the following potting materials can be recommended: non-flexible epoxy resins with acid-anhydride hardeners; chemically inert, non-conducting fillers; maximum curing temperature of 100  $^{\circ}$ C.

#### Caution:

Consult us first if you wish to embed uncoated types!





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#### Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Торіс	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"



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Торіс	Safety information	Reference chapter "Mounting guidelines
Soldering	Do not exceed the specified time or temperature	1 "Soldering"
ooldening	limits during soldering.	loodening
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of	When embedding finished circuit assemblies in	3 "Embedding of
capacitors in	plastic resins, chemical and thermal influences	capacitors in finished
finished assemblies	must be taken into account.	assemblies"
	Caution: Consult us first, if you also wish to	
	embed other uncoated component types!	



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# Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
$\alpha_{c}$	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
βc	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C <sub>R</sub>	Rated capacitance	Nennkapazität
$\Delta C$	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative	Relative Kapazitätsänderung (relative
	deviation of actual value)	Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation	Kapazitätstoleranz (relative Abweichung
	from rated capacitance)	vom Nennwert)
dt	Time differential	Differentielle Zeit
$\Delta t$	Time interval	Zeitintervall
$\Delta T$	Absolute temperature change	Absolute Temperaturänderung
	(self-heating)	(Selbsterwärmung)
$\Delta tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
$\Delta V$	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate	Differentielle Spannungsänderung
	of voltage rise)	(Spannungsflankensteilheit)
$\Delta V / \Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f <sub>1</sub>	Frequency limit for reducing permissible	Grenzfrequenz für thermisch bedingte
	AC voltage due to thermal limits	Reduzierung der zulässigen
		Wechselspannung
f <sub>2</sub>	Frequency limit for reducing permissible	Grenzfrequenz für strombedingte
	AC voltage due to current limit	Reduzierung der zulässigen
		Wechselspannung
f <sub>r</sub>	Resonant frequency	Resonanzfrequenz
F <sub>D</sub>	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur
-	Deroting factor	Diffusion
F <sub>T</sub>	Derating factor	Deratingfaktor
1	Current (peak)	Stromspitze
I <sub>C</sub>	Category current (max. continuous	Kategoriestrom (max. Dauerstrom)
	current)	



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Symbol	English	German
I <sub>RMS</sub>	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
iz	Capacitance drift	Inkonstanz der Kapazität
k <sub>o</sub>	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λο	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
$\lambda_{\text{test}}$	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
$P_{diss}$	Dissipated power	Abgegebene Verlustleistung
$P_{gen}$	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
Ri	Internal resistance	Innenwiderstand
R <sub>ins</sub>	Insulation resistance	Isolationswiderstand
R <sub>P</sub>	Parallel resistance	Parallelwiderstand
Rs	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
$tan \; \delta_{\scriptscriptstyle D}$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ <sub>P</sub>	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan δ <sub>s</sub>	Series component of dissipation factor	Serienanteil des Verlustfaktors
T <sub>A</sub>	Ambient temperature	Umgebungstemperatur
T <sub>max</sub>	Upper category temperature	Obere Kategorietemperatur
T <sub>min</sub>	Lower category temperature	Untere Kategorietemperatur
t <sub>oL</sub>	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
0L	and voltage	-spannung
Top	Operating temperature	Beriebstemperatur
T <sub>R</sub>	Rated temperature	Nenntemperatur
T <sub>ref</sub>	Reference temperature	Referenztemperatur
t <sub>SL</sub>	Reference service life	Referenz-Lebensdauer
V <sub>AC</sub>	AC voltage	Wechselspannung



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Symbol	English	German
V <sub>c</sub>	Category voltage	Kategoriespannung
V <sub>C,RMS</sub>	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V <sub>CD</sub>	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
$V_{ch}$	Charging voltage	Ladespannung
V <sub>DC</sub>	DC voltage	Gleichspannung
$V_{\text{FB}}$	Fly-back capacitor voltage	Spannung (Flyback)
Vi	Input voltage	Eingangsspannung
Vo	Output voltage	Ausgangssspannung
$V_{op}$	Operating voltage	Betriebsspannung
V <sub>p</sub>	Peak pulse voltage	Impuls-Spitzenspannung
$V_{pp}$	Peak-to-peak voltage Impedance	Spannungshub
V <sub>R</sub>	Rated voltage	Nennspannung
ν <sub>R</sub>	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
$V_{\text{RMS}}$	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
V	root-mean-square value	Channing bai Anwandung "C correction"
V <sub>sc</sub>	S-correction voltage	Spannung bei Anwendung "S-correction"
$V_{sn}$	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß

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